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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/020,594	12/13/2001	Jurgen Schredl	70408	7149
7590 04/02/2004		EXAMINER		
McGLEW AND TUTTLE			TRAN, LEN	
John James McGlew Scarborough Station			ART UNIT	PAPER NUMBER
Scarborough, NY 10510-0827			1725	
			DATE MAILED: 04/02/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
Office Action Summary	10/020,594	SCHREDL ET AL.			
onice Action Summary	Examiner	Art Unit			
The MAILING DATE of this area.	Len Tran	1725			
The MAILING DATE of this communication of the Period for Reply	ation appears on the cover sheet wit	th the correspondence address			
A SHORTENED STATUTORY PERIOD FOI THE MAILING DATE OF THIS COMMUNIC. - Extensions of time may be available under the provisions of after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) of If NO period for reply is specified above, the maximum statuths. - Failure to reply within the set or extended period for reply with Any reply received by the Office later than three months after earned patent term adjustment. See 37 CFR 1.704(b).	ATION. 37 CFR 1.136(a). In no event, however, may a re ication. days, a reply within the statutory minimum of thirty only period will apply and will expire SIX (6) MONT. Let by statute cause the application to become ARI.	ply be timely filed (30) days will be considered timely. HS from the mailing date of this communication.			
Status					
1) Responsive to communication(s) filed	on 31 December 2003				
)⊠ This action is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims					
4) Claim(s) 1-20 is/are pending in the app 4a) Of the above claim(s) is/are 5) Claim(s) is/are allowed. 6) Claim(s) 1-20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restrictio	withdrawn from consideration.				
Application Papers	. and or crossion requirement.				
9) The specification is objected to by the E	Vaminor				
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for a) All b) Some * c) None of: 1. Certified copies of the priority doc 2. Certified copies of the priority doc 3. Copies of the certified copies of the application from the International * See the attached detailed Office action for	cuments have been received. cuments have been received in App he priority documents have been re Bureau (PCT Rule 17.2(a)).	olication No eceived in this National Stage			
Attachment(s) 1) Notice of References Cited (PTO-892)	. □	(1770, 440)			
1)					
3) Information Disclosure Statement(s) (PTO-1449 or PTO Paper No(s)/Mail Date	5) Notice of Info 6) Other:	rmal Patent Application (PTO-152)			

Application/Control Number: 10/020,594

Art Unit: 1725

DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 3. Claims 1-9, 12-15, and 17-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Leicht et al(US 5,551,627), and further in view of Gotman (US 4,404,453).

Leitcht et al disclose the process for producing a contact structure for connecting two substrates comprising the steps of applying solder material to terminal to form spacing metallizations, and bonding the first substrate to the second substrate, wherein the solder is a spherical shape (figure 3, col. 4, lines 5-9). An adhesive compound is applied to the solder (col. 4, lines 40-51).

Application/Control Number: 10/020,594

Art Unit: 1725

Leicht et al fail to disclose partially fusing the solder with a laser energy.

However, Gotman discloses using laser energy to partially melt the solder (col. 3, lines 19-22) for the purpose of avoiding or minimizing any damage to the parts being attached together (col. 2, lines 35-40).

Therefore, it would have been obvious to one of ordinary skill in the art at the time applicant's invention was made to provide a laser heating means to partially melt the solder as taught by Gotman, in Leicht et al in order to prevent any damage to the parts.

4. Claims 10, 11, and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Leicht et al (US 5,551,627), and further in view of Beddingfield et al (US 5,710,071).

Leicht et al disclose the claimed invention above in paragraph 3, but fail to teach filling the gap between the substrates with a filler material.

However, Beddingfield et al disclose applying a filler (encapsulant) material in the gap of the substrates for the purpose of expelling any trap air and to prevent the chip from warping (abstract).

Therefore, it would have been obvious to one of ordinary skill in the art at the time applicant's invention was made to have filler material in between the substrates as taught by Beddingfield et al, in Leicht et al in order to expel air and prevent warping.

Response to Arguments

5. Applicant's arguments filed on September 26, 2003 have been fully considered but they are not persuasive.

Applicant argues that Gotmann fails to teach partial fusion of the spacing metallizations leaving an essential part of said spacing metallizations in its solidified state. Examiner respectfully disagrees, since col. 3, lines 19-22 discloses the claimed invention. The solder globules are partially liquefied before the contact occurs as claimed. Applicant did not distinctively claim that partial melting took place before or during bonding. Therefore, claims 1-20 remain rejected.

Inquiry

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Len Tran whose telephone number is (571) 272-1184. The examiner can normally be reached on M-F, 8:30 - 5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Dunn can be reached on (571) 272-1171. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Page 5

Application/Control Number: 10/020,594

Art Unit: 1725

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Len Tran
Examiner
Art Unit 1725

LT March 12, 2004

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